

# Product Security Vulnerability Report – LPC#5

## Subject

“Impersonation in the Passkey Entry Protocol” vulnerability

## Dialog Product Category

Connectivity > Bluetooth low energy

## Vulnerability Reference

Research published in a paper by ANSSI titled “Testing for weak key management in Bluetooth Low Energy implementations”.

Bluetooth SIG statement regarding the ‘Impersonation in the Passkey Entry Protocol’ Vulnerability.

Declared as CVE-2020-26558

## Vulnerability Description

The ANSSI paper describes how LE Secure connections pairing with Passkey authentication procedure can be subjected to a man-in-the-middle (MITM) attack. An attacker has to be in the vicinity of the initiating and responding devices at the time of pairing. The attacker impersonates the initiator by reflecting the genuine responses, establishing the attacker as an initiator to the responder. In order for the attack to succeed it has to attack all 20 times involving 20 bits of the 6-digit Passkey during the Passkey authentication procedure. The attacker does not succeed in impersonating the responder by this method, preventing a fully transparent MITM attack on the pairing procedure between the initiator and responder.

This attack exposes a vulnerability in the Bluetooth specification, it is not an implementation vulnerability.

## Impact

Once the MITM attacker is acknowledged by the responding device as a credible initiator, the responder will be authenticated to the attacker rather than the initiator, permitting the attacker to act in the role of an encrypted and authenticated initiator. Both the application data on logical connection and GATT services can be accessed by the attacker. In cases where the responder supports GATT client role, the

attacker can manipulate the GATT service characteristics. In cases where the responder supports GATT server role, the attacker accesses the GATT service characteristics.

## Dialog Response Summary

Analysis has been conducted by the Product Security Incident Response Team (PSIRT) and the reported specification vulnerability has been verified by Dialog Engineering. All of Dialog’s Bluetooth low energy products that support LE Secure Connections are impacted.

The PSIRT assessment is that this incident constitutes a medium risk (with CVSS rating 4.6) and an SDK fix roll-out will be conducted according to use-case severity.

The Dialog fix design will follow the guidance from Bluetooth SIG.

## Product Mitigation

<i>Product</i>	<i>SDK</i>	<i>Impacted</i>	<i>SDK fix</i>	<i>available</i>
DA14530	SDK6	Y	6.0.16	Q3-2021
DA14531	SDK6	Y	6.0.16	Q3-2021
DA14580	SDK3	N	not applicable	
	SDK5	N	not applicable	
DA14581	SDK3	N	not applicable	
	SDK5	N	not applicable	
DA14583	SDK3	N	not applicable	
	SDK5	N	not applicable	
DA14585	SDK6	Y	6.0.16	Q3-2021
DA14585-00T	SDK6	Y	6.0.16	Q3-2021
DA14586	SDK6	Y	6.0.16	Q3-2021
DA14680	SDK1	Y	to be decided	
DA14681-01	SDK1	Y	to be decided	
DA14682	SDK1	Y	to be decided	
DA14683	SDK1	Y	to be decided	
DA14691	SDK10	Y	10.0.12	Q4-2021
DA14695	SDK10	Y	10.0.12	Q4-2021
DA14697	SDK10	Y	10.0.12	Q4-2021
DA14699	SDK10	Y	10.0.12	Q4-2021

### Notes:

1. the SDK1 fix plan will be defined once the use-case severity has been determined.
2. “not impacted” products do not support LE Secure Connections so the vulnerability does not exist. Therefore an SDK fix is not applicable.

## Fix Availability

SDK's will be posted to the Resources section of the appropriate product page on the Dialog website.

## Contact

If you have any information regarding Dialog product security vulnerabilities, please write to [PSIRT@diasemi.com](mailto:PSIRT@diasemi.com) (in English).

For general support questions please contact the support forum:

<https://support.dialog-semiconductor.com/forum>

## Revision History

Revision	Date	Description
1	<16-June 2021>	Initial version.

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